



Kingston Technology FURY Renegade Pro módulo de memoria 16 GB 1 x 16 GB DDR5 3000 MHz ECC

Marca : Kingston Technology Familia de productos: FURY Código del producto: KF560R32RB-16

Nombre del producto : 16GB
6000MT/s DDR5 ECC Reg CL32
DIMM FURY Renegade Pro XMP

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Sobreaceleración con ECC

Mantiene la integridad de los datos trascendiendo los límites del rendimiento DDR5.

Mayor eficacia

Con el doble de bancos y de velocidades de ráfaga, satisface las demandas de los programas y aplicaciones más recientes con una mayor eficacia y menores latencias.

Homologación Intel® XMP 3,0

Seleccione alguno de los perfiles integrados para maximizar el rendimiento de la memoria con avanzadas temporizaciones, velocidades y tensiones preoptimizadas.

AMD EXPO (Extended Profiles for Overclocking)

Entre los módulos certificados se incluyen los perfiles Intel XMP 3.0, lo que facilita la compatibilidad con la plataforma que elijas.

Plug N Play**

Los módulos Kingston FURY Renegade Pro DDR5 RDIMM se sobreaceleran automáticamente hasta la velocidad de referencia más alta.

Features		Features	
Buffered memory type	Registered (buffered)	Cooling type	Heatsink
On-Die ECC	✓	Lead plating	Gold
CAS latency	32	JEDEC standard	✓
Internal memory *	16 GB	Operational conditions	
Memory layout (modules x size) *	1 x 16 GB	Operating temperature (T-T)	0 - 95 °C
Internal memory type *	DDR5	Storage temperature (T-T)	-55 - 100 °C
Memory clock speed *	3000 MHz	Technical details	
Memory data transfer rate	6000 MT/s	Compliance certificates	RoHS
Component for *	PC/Server	Sustainability	
Memory form factor *	288-pin DIMM	Doesn't contain	Halogen
ECC *	✓	Weight & dimensions	
Memory ranking	1	Width	3.8 mm
Memory voltage	1.35 V	Depth	133.3 mm
Module configuration	2048M x 8	Height	31.2 mm
Row cycle time	48 ns	Weight	18.2 g
Refresh row cycle time	295 ns	Packaging data	
Row active time	32 ns	Package width	57.1 mm
Intel Extreme Memory Profile (XMP)	✓	Package depth	14 mm
Intel Extreme Memory Profile (XMP) version	3.0	Package height	171.4 mm
SPD profile	✓	Package weight	34.72 g
Programming power voltage (VPP)	1.8 V	Logistics data	
Country of origin	China, Taiwan	Master (outer) case width	196.8 mm
Product colour	Black	Master (outer) case length	311.1 mm
		Master (outer) case height	61 mm
		Master (outer) case gross weight	1.15 kg

Logistics data

Products per master (outer) case 25 pc(s)



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